

/ Descriptions

VRW056 MM E QSQ Æ M ȳ s ll 1

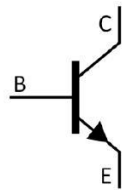
/ Features

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/ Applications

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/ Equivalent Circuit



/ Pinning



X

X

X

/ hFE Classifications & Marking

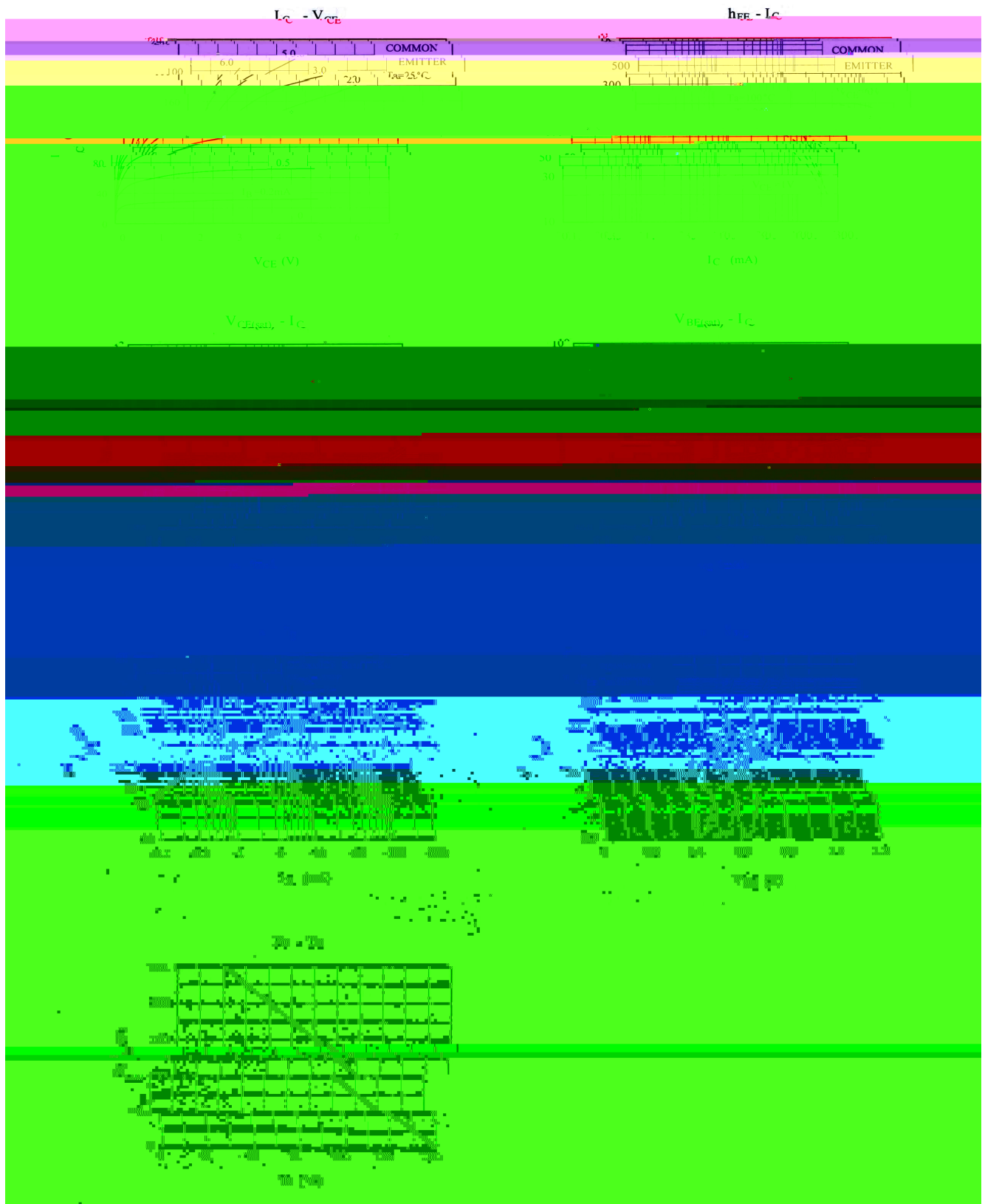
/ Absolute Maximum Ratings(Ta=25)

V _{DS}	I _D	T _J	θ _{JA}

/ Electrical Characteristics(Ta=25)

V _{DS}	I _D	f _{sw}	Q _g	Q _{rr}	Q _{rr}	θ _{JA}

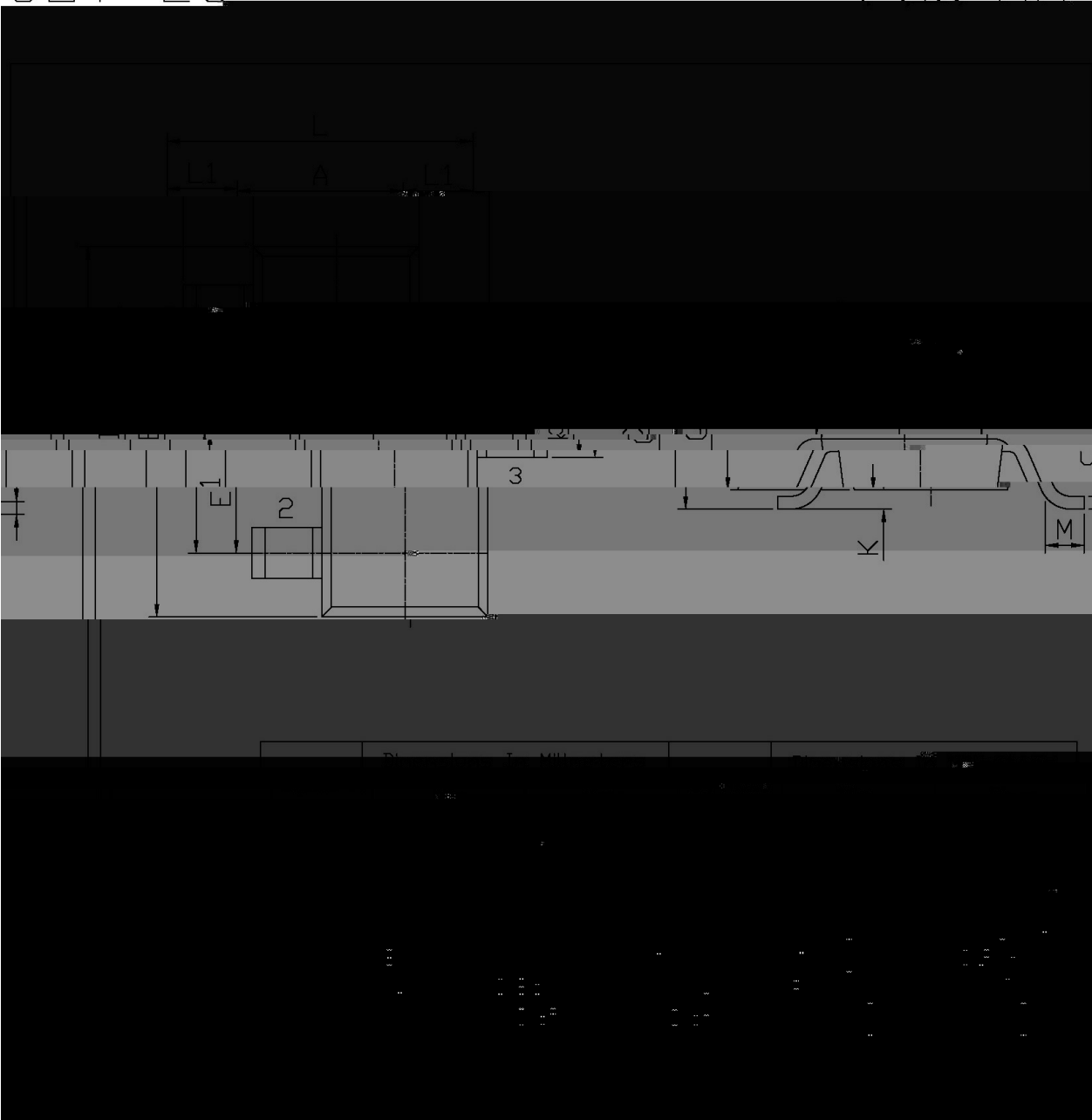
/ Electrical Characteristic Curve

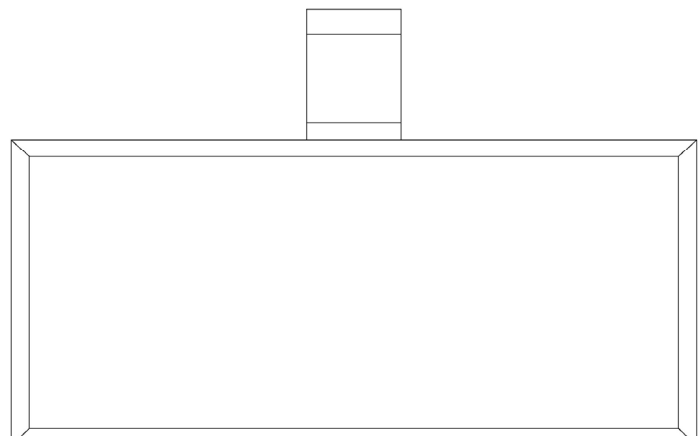


/ Package Dimensions

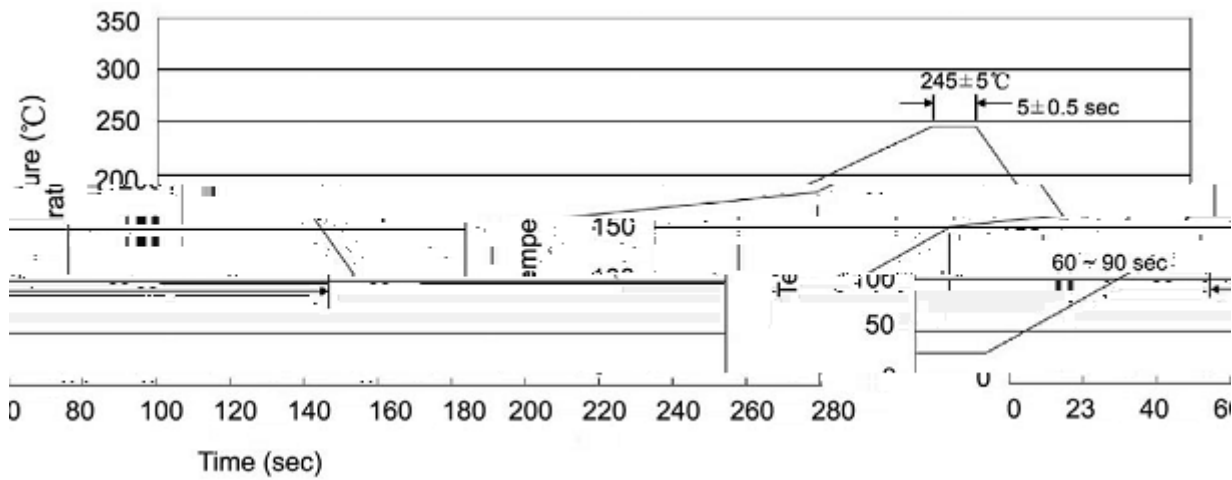
SOT-23

单位：mm





() / Temperature Profile for IR Reflow Soldering(Pb-Free)



1. 焊接温度: 245±5°C

2. 峰值时间: 5±0.5 sec

3. 预热时间: 60~90 sec

/ Resistance to Soldering Heat Test Conditions

1. 焊接温度: 245±5°C

2. 峰值时间: 5±0.5 sec

3. 预热时间: 60~90 sec

/ Packaging SPEC.

1. 包装形式: SOT-23

2. 包装数量: 3,000

3. 包装尺寸: 180×120×180

封装形式	包装数量					包装尺寸		
	Units/Reel 只/卷盘	Reels/Inner Box 卷盘/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Reel	Inner Box 盒	Outer Box 箱
SOT-23	3,000	10	30,000	6	180,000	7 ×8	180×120×180	390×385×205

/ Notices